TSF18N20M

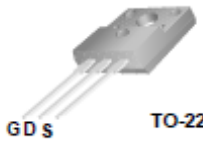
200V N-Channel MOSFET

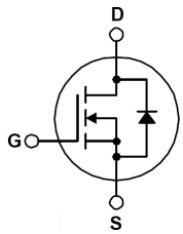
General Description

This Power MOSFET is produced using Truesemi's advanced planar stripe DMOS technology.
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Features

- 18A,200V,Max.$R_{DS(on)}$=0.17 Ω @ V_{GS} =10V
- Low gate charge(typical 22nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability





Absolute Maximum Ratings

T_C=25℃ unless otherwise specified

Symbol	Parameter		Value	Units
V_{DSS}	Drain-Source Voltage		200	V
V_{GS}	Gate-Source Voltage		±30	V
I_D	Drain Current	T_C = 25℃	18*	A
		T_C = 100℃	9.1*	A
I_{DM}	Pulsed Drain Current		72*	A
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	453	mJ
E_{AR}	Repetitive Avalanche Energy	(Note 1)	13.9	mJ
I_{AR}	Repetitive avalanche current	(Note 1)	18	A
P_D	Power Dissipation (T_C = 25℃)		35	W
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	℃

* Drain current limited by maximum junction temperature.

Thermal Resistance Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	3.57	℃/W
$R_{\theta JA}$	Thermal Resistance,Junction-to-Ambient	62.5	℃/W

Electrical Characteristics T_C=25 ℃ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 uA	2.0	--	4.0	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS} = 10 V, I_D = 9A	--	0.14	0.17	Ω
g_{fs}	Forward transfer conductance(note 3)	V_{DS} = 10 V, I_D = 9A	--	10.5	--	S
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 uA	200	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 200 V, V_{GS} = 0 V	--	--	1	uA
I_{GSSF}	Gate-Body Leakage Current,Forward	V_{GS} = 30 V, V_{DS} = 0 V	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current,Reverse	V_{GS} =- 30 V, V_{DS} = 0 V	--	--	-100	nA
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	--	942	1240	pF
C_{oss}	Output Capacitance		--	227	310	pF
C_{rss}	Reverse Transfer Capacitance		--	55	71	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Time	V_{DS} = 125 V, I_D = 18A, R_G = 25 Ω (Note 3,4)	--	15	--	ns
t_r	Turn-On Rise Time		--	130	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	135	--	ns
t_f	Turn-Off Fall Time		--	105	--	ns
Q_g	Total Gate Charge	V_{DS} = 160 V, I_D = 18A, V_{GS} = 10 V (Note 3,4)	--	22	28	nC
Q_{gs}	Gate-Source Charge		--	6.6	--	nC
Q_{gd}	Gate-Drain Charge		--	7.2	--	nC
Source-Drain Diode Maximum Ratings and Characteristics						
I_S	Continuous Source-Drain Diode Forward Current		--	--	18	A
I_{SM}	Pulsed Source-Drain Diode Forward Current (Note 1)		--	--	72	A
V_{SD}	Source-Drain Diode Forward Voltage	I_S = 18A, V_{GS} = 0 V	--	--	1.4	V
t_{rr}	Reverse Recovery Time	I_S =18A, V_{GS} = 0 V di_F/dt = 100 A/μs (Note 4)	--	208	--	ns
Q_{rr}	Reverse Recovery Charge		--	1.63	--	uC

Note:
1. Repeated rating: Pulse width limited by maximum junction temperature
2. L=2.1mH, IAS=18A, VDD=50V, RG=25Ω, Starting TJ=25℃
3. Pulse test: Pulse width≤300us, Duty cycle≤2%
4. Essentially independent of operating temperature

Typical Characteristics

Fig. 1 I_D - V_{DS}

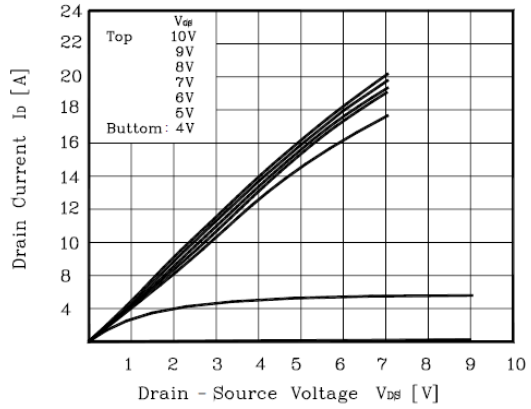


Fig. 2 I_D - V_{GS}

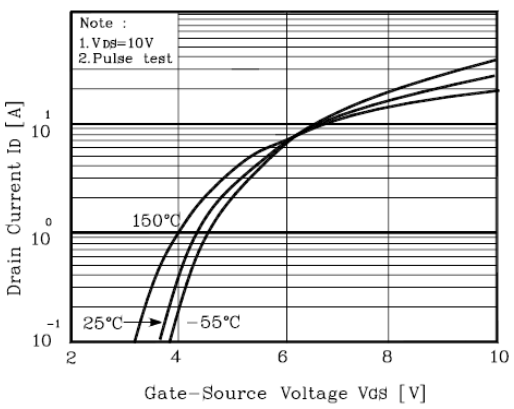


Fig. 3 $R_{DS(on)}$ - I_D

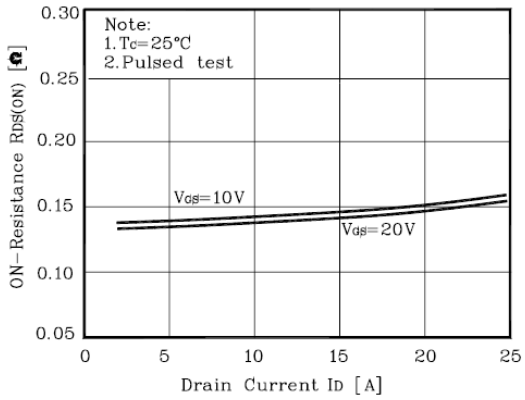


Fig. 4 I_S - V_{SD}

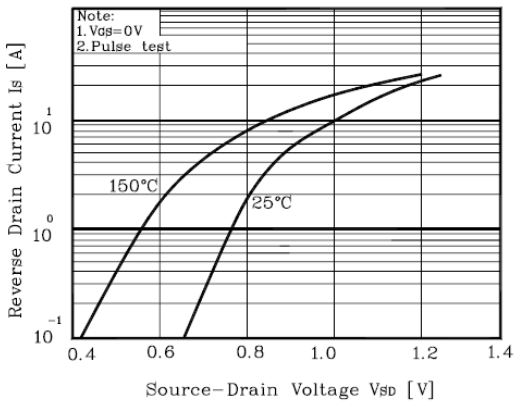


Fig. 5 Capacitance - V_{DS}

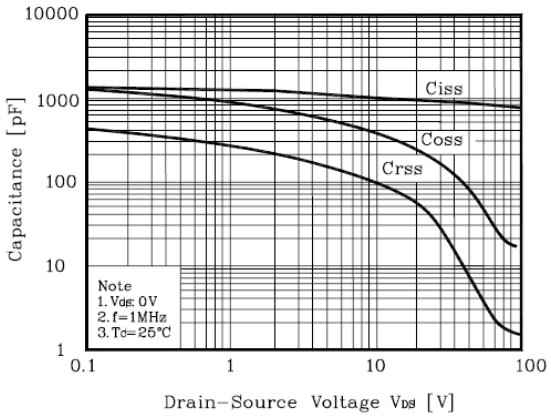
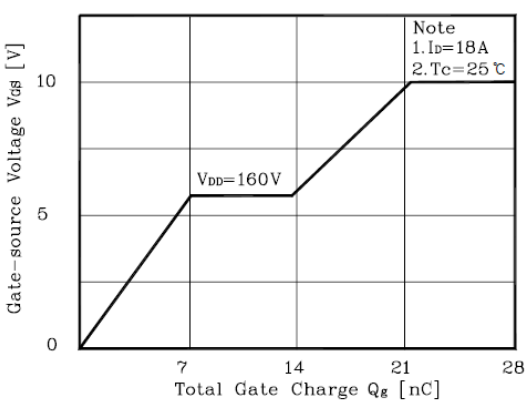


Fig. 6 V_{GS} - Q_G



Typical Characteristics

Fig. 7 V_{DSS} - T_J

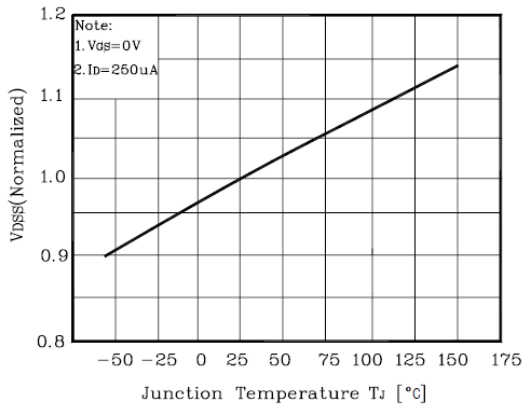


Fig. 8 $R_{DS(on)}$ - T_J

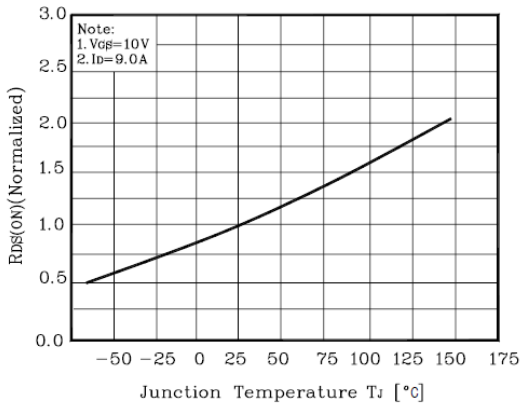


Fig. 9 I_D - T_C

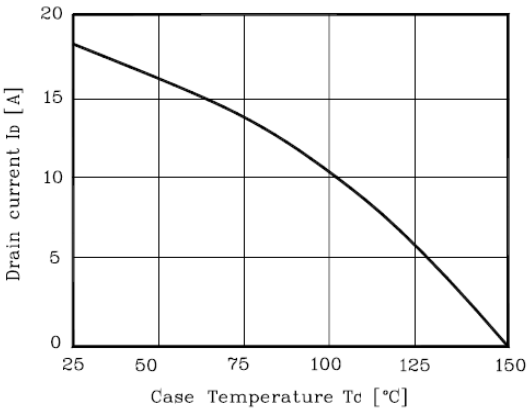


Fig. 10 Safe Operating Area

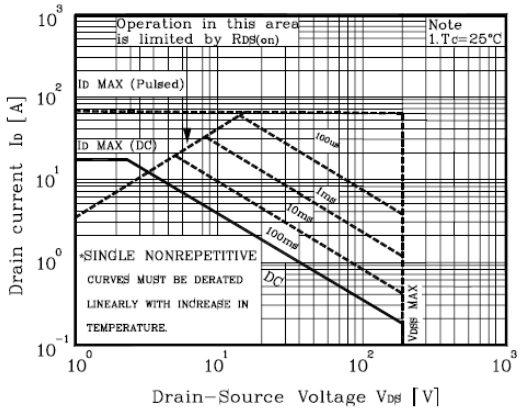


Fig 11. Gate Charge Test Circuit & Waveform

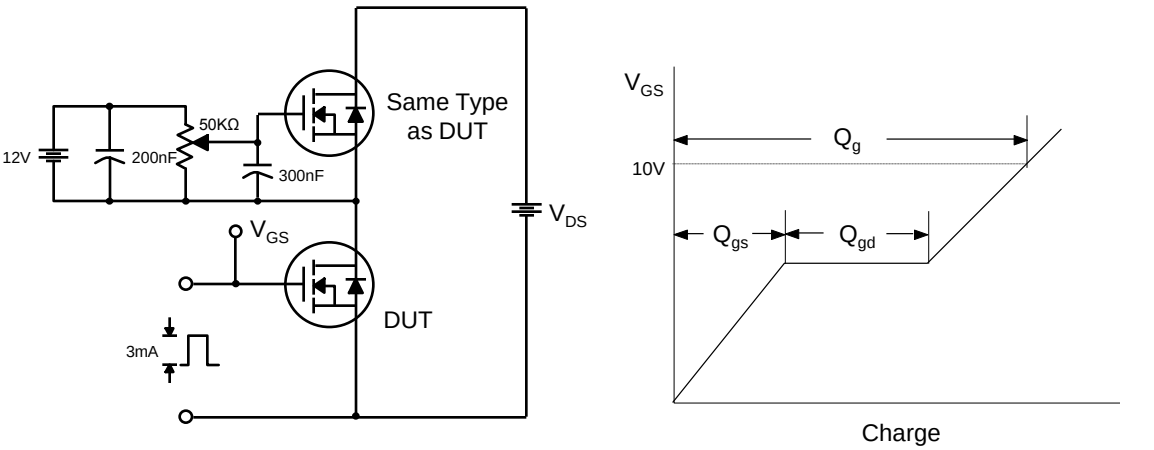


Fig 12. Resistive Switching Test Circuit & Waveforms

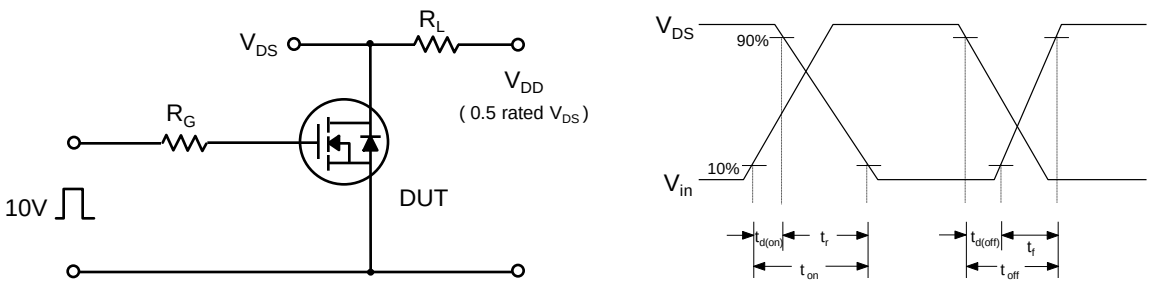


Fig 13. Unclamped Inductive Switching Test Circuit & Waveforms

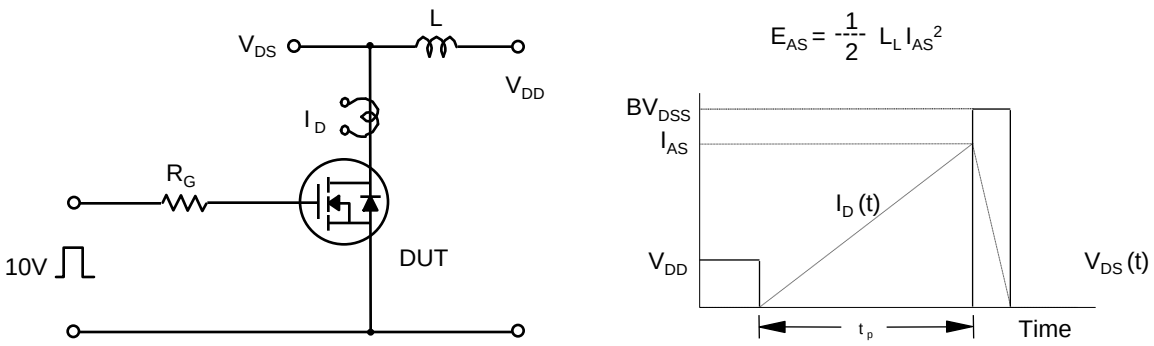


Fig 14. Peak Diode Recovery dv/dt Test Circuit & Waveforms